

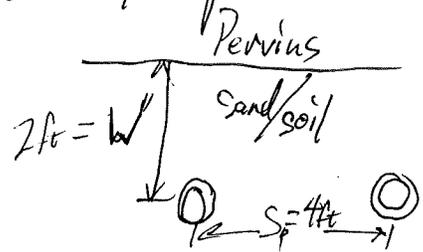
# Analytical 2-D Conduction

ME576F198.1

Thus far we've dealt with 1-D conduction problems & developed the extended surface approximation ~~to~~ to handle some 2-D problems as 1-D. We could spend more time on fins to cover moving fins, & variable area fins. The approach remains the same, the math just gets harder. Luckily many libraries are available that tabulate most known solutions for convenient use. (Show EES: Options → Function Info → HT & Fluid Flow → Fins)

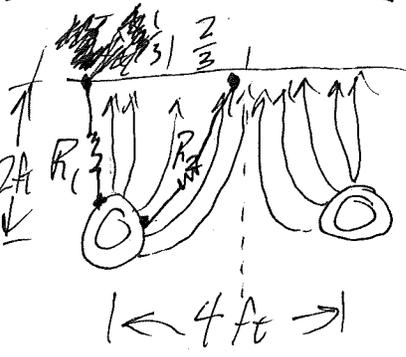
At some point though, we will no longer be able to use 1-D approximation.

Example: WSU's Civil Engineering Department helped to develop pervious concrete/pavement solutions such as the rotunda in front of the Allen School of Global Animal Health or the sidewalk in front of Sloan. These systems collect ground water within a packed sand & gravel layer to reduce runoff. One day during conversation the idea of using one of these systems as a ground coupled heat pump came up. The water stored in the "basin" is basically a giant thermal mass at a relatively constant temp. But the concern is that heat transfer to the surface on a cold day will freeze fluid in the observation/research 'well' that we would use as the heat exchanger. At what depth  $w$  should the well be placed in the sand bed?



Step 0: Quick calcs to figure out what problem we are trying to solve.

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Heat transfer is definitely 2D in this problem, but how much so?  $R_i = \frac{\text{resistance you want to neglect}}{\text{resistance you want to consider}}$

$$R_i = \frac{R_2}{R_1} = \frac{\sqrt{2} \frac{w}{kA}}{\frac{w}{kA}} \Rightarrow R_i = \sqrt{2} = 1.414 \text{ not } \ll 1$$

It would be very convenient if there was an "integrated average" resistance for this problem. Many common 2-D & 3-D surface problems have been solved & are known as "Shape Factors". The Shape Factor is:  $S = \frac{1}{kR}$  where  $k$  is the material thermal conductivity &  $R$  is the thermal resistance between the surfaces. Recall for a plane wall that  $R = \frac{th}{kA_c}$  "2-D"

$\Rightarrow S \approx \frac{A_c}{th}$  this means that Shape Factors should always be of the same order as the <sup>ratio of the</sup> cross-sectional area to the average length that heat transfer is occurring ← Great check.

★ Many Heat transfer libraries like EES often include Shape Factors (Show EES: Options → FunctionInfo → Conduction Shape Factors)

Now show EES code & plot → I could answer many of the questions to determine the feasibility of this concept with quick Shape Factor estimates!

But what if we can't find the Shape Factor we need?

# Separation of Variables

ME516 Sp20138-3

→ Most common technique for solving Partial Differential Equations used in a number of engineering fields

→ ~~splitting~~ solution involves splitting your PDE into 2 ODEs that can be solved using techniques we have developed for 1-D problems

## Requirements for Separation of Variables (SOV)

1) PDE must be linear; i.e. cannot contain any products of temperature or its derivative

Example non-linear:  $T \frac{\partial^2 T}{\partial x^2} + \frac{\partial T}{\partial x} \frac{\partial^2 T}{\partial y^2} = 0$

linear:  $\frac{\partial^2 T}{\partial x^2} + \frac{\partial T}{\partial x} + \frac{\partial^2 T}{\partial y^2} + T = 0$

2) PDE must be homogeneous; i.e. if  $T$  is a solution, then  $CT$  must also be a solution (where  $C$  is any constant)

non-homogeneous:  $\frac{\partial^2 T}{\partial x^2} + \frac{\partial T}{\partial x} + \frac{\partial^2 T}{\partial y^2} + T = T_0$

$CT$  doesn't <sup>always</sup> =  $T_0$

homogeneous:  $\frac{\partial^2 T}{\partial x^2} + \frac{\partial T}{\partial x} + \frac{\partial^2 T}{\partial y^2} + T = 0$

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3) All BC's must be linear

→ cannot contain any products of temperature or its derivative

$$\text{non-linear: } -k \frac{\partial T}{\partial x} \Big|_{x=L} = \alpha \epsilon T_{x=L}^4$$

$$\text{linear: } -k \frac{\partial T}{\partial x} \Big|_{x=L} = h (T_{x=L} - T_\infty)$$

4) Both BC's ~~must be in~~ ~~the~~ the homogeneous direction must be homogeneous

→ if  $T$  satisfies BC's, then  $CT$  must also satisfy BC's

→ BC's in other direction do not have to be homogeneous

$$\text{non-homogeneous: } -k \frac{\partial T}{\partial x} \Big|_{x=L} = h (T_{x=L} - T_\infty)$$

$$\text{homogeneous: } -k \frac{\partial T}{\partial x} \Big|_{x=L} = h T_{x=L}$$

5) Computational domain must be "simple", i.e. boundaries must lie along lines of constant coordinates (e.g.  $x=L$ )

Work through the solution steps.

Now we are ready to attempt a problem.